Dual High Voltage Common Cathode Switching Diode

Features

- Moisture Sensitivity Level: 1
- ESD Rating Human Body Model: Class 2 – Machine Model: Class C
- Fast Switching Speed
- Switching Application
- This is a Halide–Free Device
- This is a Pb–Free Device

Typical Applications

- LCD TV
- Power Supply
- Industrial

MAXIMUM RATINGS

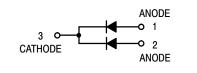
Rating	Symbol	Value	Unit
Continuous Reverse Voltage	V _R	250	V
Repetitive Peak Reverse Voltage	V _{RRM}	250	V
Peak Forward Current	١ _F	400	mA
$ \begin{array}{ll} \mbox{Non-Repetitive Peak} & @\ t = 1.0 \ \mu s \\ \mbox{Forward Surge Current} & @\ t = 100 \ \mu s \\ @\ t = 10 \ m s \\ \end{array} $	I _{FSM}	9.0 3.0 1.7	A
Peak Forward Surge Current	I _{FM(surge)}	625	mAdc
Non-Repetitive Peak Per Human Body Model Per Machine Model	HBM MM	4.0 400	kV V

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.



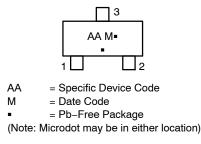
ON Semiconductor®

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MARKING DIAGRAM



ORDERING INFORMATION

Device	Package	Shipping [†]
BAV23CLT1G	SOT-23 (Pb-Free)	3000/Tape & Reel

+For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

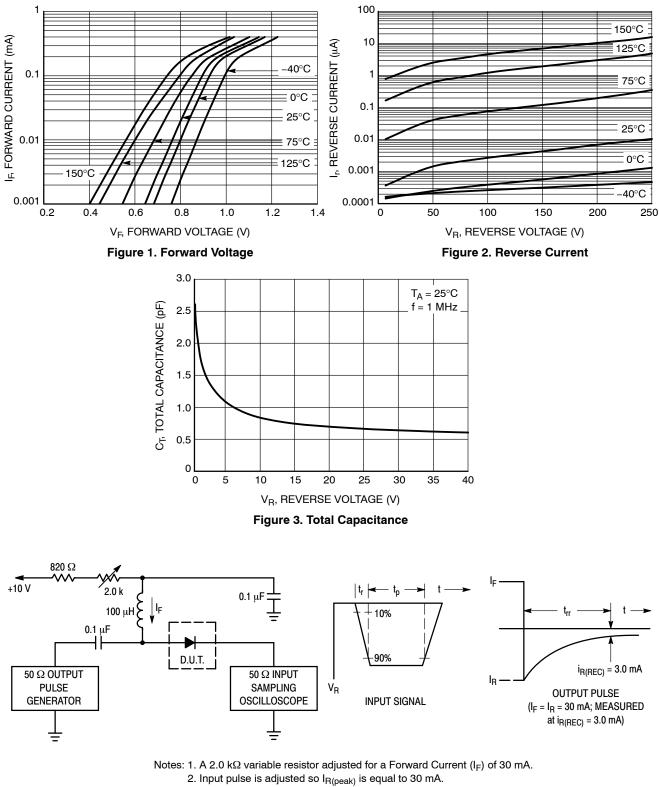
THERMAL CHARACTERISTICS

Characteristic	Symbol	Max	Unit
SINGLE HEATED			•
Total Device Dissipation (Note 1) T _A = 25°C Derate above 25°C	P _D	265 2.1	mW mW/°C
Thermal Resistance, Junction-to-Ambient (Note 1)	$R_{ extsf{ heta}JA}$	472	°C/W
Thermal Reference, Junction-to-Anode Lead (Note 1)	R_ _{yJL}	263	°C/W
Thermal Reference, Junction-to-Case (Note 1)	R_ψ _{JC}	289	°C/W
Total Device Dissipation (Note 2) T _A = 25°C Derate above 25°C	PD	345 2.7	mW mW/°C
Thermal Resistance, Junction-to-Ambient (Note 2)	$R_{ hetaJA}$	362	°C/W
Thermal Reference, Junction-to-Anode Lead (Note 2)	R_ _{yJL}	251	°C/W
Thermal Reference, Junction-to-Case (Note 2)	R_ _{yJC}	250	°C/W
DUAL HEATED (Note 3)	•		
Total Device Dissipation (Note 1) T _A = 25°C Derate above 25°C	PD	390 3.1	mW mW/°C
Thermal Resistance, Junction-to-Ambient (Note 1)	$R_{ hetaJA}$	321	°C/W
Thermal Reference, Junction-to-Anode Lead (Note 1)	R_ _{yJL}	159	°C/W
Thermal Reference, Junction-to-Case (Note 1)	R_ψ _{JC}	138	°C/W
Total Device Dissipation (Note 2) T _A = 25°C Derate above 25°C	PD	540 4.3	mW mW/°C
Thermal Resistance, Junction-to-Ambient (Note 2)	$R_{ ext{ heta}JA}$	231	°C/W
Thermal Reference, Junction-to-Anode Lead (Note 2)	R_ _{yJL}	148	°C/W
Thermal Reference, Junction-to-Case (Note 2)	R_ψ _{JC}	119	°C/W
Junction and Storage Temperature Range	T _J , T _{stg}	–55 to +150	°C

FR-4 @ 100 mm², 1 oz. copper traces, still air.
FR-4 @ 500 mm², 2 oz. copper traces, still air.
Dual heated values assume total power is sum of two equally powered channels

ELECTRICAL CHARACTERISTICS (T_A = 25°C unless otherwise noted)

Characteristic	Symbol	Min	Max	Unit		
OFF CHARACTERISTICS						
Reverse Voltage Leakage Current ($V_R = 200 \text{ Vdc}$) ($V_R = 200 \text{ Vdc}$, T _J = 150°C)	I _R		0.1 100	μAdc		
Reverse Breakdown Voltage (I _{BR} = 100 μAdc)	V _(BR)	250	_	Vdc		
Forward Voltage (I _F = 100 mAdc) (I _F = 200 mAdc)	V _F		1000 1250	mV		
Diode Capacitance ($V_R = 0, f = 1.0 \text{ MHz}$)	CT	-	5.0	pF		
Reverse Recovery Time ($I_F = I_R = 30 \text{ mAdc}, R_L = 100 \Omega$)	t _{rr}	-	150	ns		

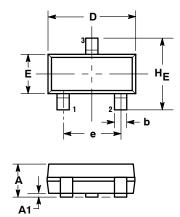


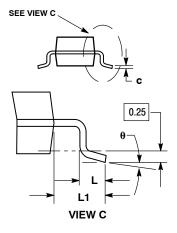




PACKAGE DIMENSIONS

SOT-23 (TO-236) CASE 318-08 **ISSUE AN**





NOTES

- DIMENSIONING AND TOLERANCING PER ANSI 1.
- V14.5M, 1982. CONTROLLING DIMENSION: INCH. MAXIMUM LEAD THICKNESS INCLUDES LEAD FINISH THICKNESS. MINIMUM LEAD 3 THICKNESS IS THE MINIMUM THICKNESS OF BASE MATERIAL.
- 318-01 THRU -07 AND -09 OBSOLETE, NEW STANDARD 318-08.

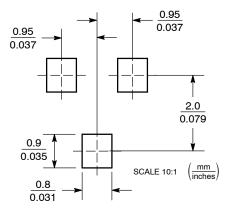
	MILLIMETERS			INCHES		
DIM	MIN	NOM	MAX	MIN	NOM	MAX
Α	0.89	1.00	1.11	0.035	0.040	0.044
A1	0.01	0.06	0.10	0.001	0.002	0.004
b	0.37	0.44	0.50	0.015	0.018	0.020
С	0.09	0.13	0.18	0.003	0.005	0.007
D	2.80	2.90	3.04	0.110	0.114	0.120
Е	1.20	1.30	1.40	0.047	0.051	0.055
е	1.78	1.90	2.04	0.070	0.075	0.081
L	0.10	0.20	0.30	0.004	0.008	0.012
L1	0.35	0.54	0.69	0.014	0.021	0.029
HE	2.10	2.40	2.64	0.083	0.094	0.104

2. ANODE CATHODE З.

STYLE 9:

PIN 1. ANODE





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